

TAZMO®



Spin Coater/ Developer

[CSX3000 SERIES]

● Overview

TAZMO Spin coater/developer CSX3000 series are designed to meet 3D IC backend process applications including Cu pillar, Solder Bump and RDL. In order to forming such interconnects variety of films need to be coated and developed with high film uniformity and minimum cost. CSX3000 series is expanding the install base in the major production line and satisfying customer demands with lower CoO performance.

● Features

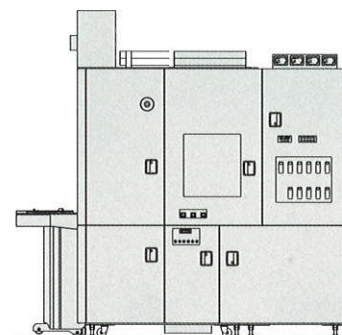
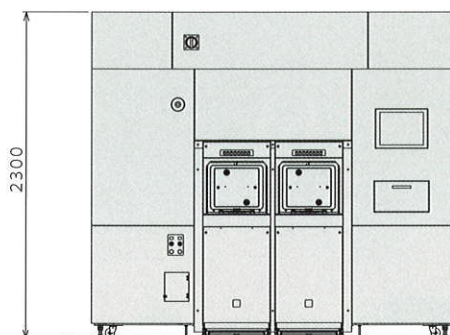
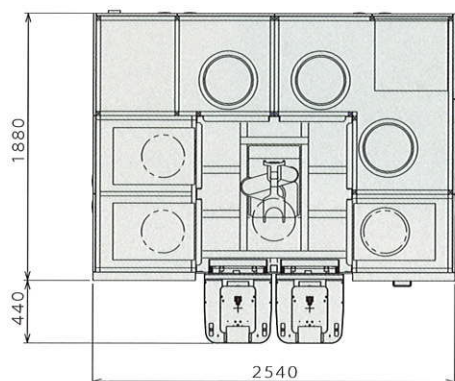
- Enable Very Low consumption of expensive coating chemical such as Polyimide.
- High consistency and uniformity for high viscosity chemical Bump forming photo resist with low chemical consumption.
- Offer reasonable cost and highly reliable wafer transfer system by using original own made robot system.

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● Configuration

- Wafer size 8 - 12inch
- Coating unit Max.3unit
- Developer unit Max.4unit
- Bake plate Max.8unit
- Cool plate Max.4unit



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